FAIRCHILD

SEMICONDUCTOR®

FSBM15SL60

SPM[™] (Smart Power Module)

General Description

FSBM15SL60 is an advanced smart power module (SPM) that Fairchild has newly developed and designed to provide very compact and high performance ac motor drives mainly targeting low speed low-power inverter-driven application like air conditioners. It combines optimized circuit protection and drive matched to low-loss IGBTs. Highly effective short-circuit current detection/protection is realized through the use of advanced current sensing IGBT chips that allow continuous monitoring of the IGBTs current. System reliability is further enhanced by the integrated undervoltage lock-out protection. The high speed built-in HVIC provides opto-coupler-less IGBT gate driving capability that further reduce the overall size of the inverter system design. In addition the incorporated HVIC facilitates the use of single-supply drive topology enabling the FSBM15SL60 to be driven by only one drive supply voltage without negative bias. Inverter current sensing application can be achieved due to the divided negative dc terminals.

Features

- UL Certified No. E209204
- 600V-15A 3-phase IGBT inverter bridge including control ICs for gate driving and protection
- Divided negative dc-link terminals for inverter current sensing applications
- Single-grounded power supply due to built-in HVIC
- Typical switching frequency of 3kHz
- Inverter power rating of 0.8kW / 100~253 Vac
- Isolation rating of 2500Vrms/min.
- Very low leakage current due to using ceramic substrate
- Adjustable current protection level by varying series resistor value with sense-IGBTs

Applications

- AC 100V ~ 253V 3-phase inverter drive for small power (0.8kW) ac motor drives
- Home appliances applications requiring low switching frequency operation like air conditioners drive system
- Application ratings:
 - Power : 0.8kW / 100~253 Vac
 - Switching frequency : Typical 3kHz (PWM Control)
 - 100% load current : 5.0A (Irms)
 - 150% load current : 7.5A (Irms) for 1 minute



FSBM15SL60



n Number	Pin Name	Pin Description
1	V _{CC(L)}	Low-side Common Bias Voltage for IC and IGBTs Driving
2	COM _(L)	Low-side Common Supply Ground
3	IN _(UL)	Signal Input for Low-side U Phase
4	IN _(VL)	Signal Input for Low-side V Phase
5	IN _(WL)	Signal Input for Low-side W Phase
6	COM _(L)	Low-side Common Supply Ground
7	V _{FO}	Fault Output
8	C _{FOD}	Capacitor for Fault Output Duration Time Selection
9	C _{SC}	Capacitor (Low-pass Filter) for Short-Circuit Current Detection Input
10	R _{SC}	Resistor for Short-Circuit Current Detection
11	IN _(UH)	Signal Input for High-side U Phase
12	V _{CC(UH)}	High-side Bias Voltage for U Phase IC
13	V _{B(U)}	High-side Bias Voltage for U Phase IGBT Driving
14	V _{S(U)}	High-side Bias Voltage Ground for U Phase IGBT Driving
15	IN _(VH)	Signal Input for High-side V Phase
16	COM(H)	High-side Common Supply Ground
17	V _{CC(VH)}	High-side Bias Voltage for V Phase IC
18	V _{B(V)}	High-side Bias Voltage for V Phase IGBT Driving
19	V _{S(V)}	High-side Bias Voltage Ground for V Phase IGBT Driving
20	IN _(WH)	Signal Input for High-side W Phase
21	V _{CC(WH)}	High-side Bias Voltage for W Phase IC
22	V _{B(W)}	High-side Bias Voltage for W Phase IGBT Driving
23	V _{S(W)}	High-side Bias Voltage Ground for W Phase IGBT Driving
24	NC	No Connection
25	NC	No Connection
26	NU	Negative DC-Link Input for U Phase
27	N _V	Negative DC-Link Input for V Phase
28	N _W	Negative DC-Link Input for W Phase
29	U	Output for U Phase
30	V	Output for V Phase
31	W	Output for W Phase
32	Р	Positive DC–Link Input



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Absolute Maximum Ratings (T_J = 25°C, Unless Otherwise Specified)

Inverter Part

Item	Symbol	Condition	Rating	Unit
Supply Voltage	V _{PN}	Applied between P- N_U , N_V , N_W	450	V
Supply Voltage (Surge)	V _{PN(Surge)}	Applied between P- N _U , N _V , N _W	500	V
Collector-Emitter Voltage	V _{CES}		600	V
Each IGBT Collector Current	± I _C	$T_{\rm C} = 25^{\circ}{\rm C}$	15	Α
Each IGBT Collector Current	± I _C	$T_{\rm C}$ = 100°C	10	Α
Each IGBT Collector Current (Peak)	± I _{CP}	T _C = 25°C, Instantaneous Value (Pulse)	30	A
Collector Dissipation	P _C	T _C = 25°C per One Chip	46	W
Operating Junction Temperature	Τ _J	(Note 1)	-20 ~ 125	°C

Note: 1. It would be recommended that the average junction temperature should be limited to $T_J \le 125^{\circ}C$ (@ $T_C \le 100^{\circ}C$) in order to guarantee safe operation.

Control Part

Item	Symbol	Condition	Rating	Unit
Control Supply Voltage	V _{CC}	Applied between $V_{CC(UH)}$, $V_{CC(VH)}$, $V_{CC(WH)}$ - $COM_{(H)}$, $V_{CC(L)}$ - $COM_{(L)}$	20	V
High-side Control Bias Voltage	V _{BS}	Applied between $V_{B(U)}$ - $V_{S(U)}$, $V_{B(V)}$ - $V_{S(V)}$, $V_{B(W)}$ - $V_{S(W)}$	20	V
Input Signal Voltage	V _{IN}	Applied between $IN_{(UH)}$, $IN_{(VH)}$, $IN_{(WH)}$ - $COM_{(H)}$ $IN_{(UL)}$, $IN_{(VL)}$, $IN_{(WL)}$ - $COM_{(L)}$	-0.3~V _{CC} +0.3	V
Fault Output Supply Voltage	V _{FO}	Applied between V _{FO} - COM _(L)	-0.3~V _{CC} +0.3	V
Fault Output Current	I _{FO}	Sink Current at V _{FO} Pin	5	mA
Current Sensing Input Voltage	V _{SC}	Applied between C _{SC} - COM _(L)	-0.3~V _{CC} +0.3	V

Total System

Item	Symbol	Condition	Rating	Unit
Self Protection Supply Voltage Limit (Short-Circuit Protection Capability)	V _{PN(PROT)}	$V_{CC} = V_{BS} = 13.5 \sim 16.5V$ T _J = 25°C, Non-repetitive, less than 6µs	400	V
Module Case Operation Temperature	Т _С	Note Fig.2	-20 ~ 100	°C
Storage Temperature	T _{STG}		-20 ~ 125	°C
Isolation Voltage	V _{ISO}	60Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat-sink Plate	2500	V _{rms}

Absolute Maximum Ratings

Thermal Resistance

Item	Symbol	Condition		Тур.	Max.	Unit
Junction to Case Thermal Resistance	R _{th(j-c)Q}	Each IGBT under Inverter Operating Condition		-	2.71	°C/W
	R _{th(j-c)F}	Each FWDi under Inverter Operating Condition	-	-	3.71	°C/W
Contact Thermal Resistance	R _{th(c-h)}	Ceramic Substrate (per 1 Module) Thermal Grease Applied (Note 3)	-	-	0.06	°C/W

 $\begin{array}{l} \textbf{Note:}\\ \textbf{2. For the measurement point of case temperature(T_C), please refer to Fig. 2.\\ \textbf{3. The thickness of thermal grease should not be more than 100um.} \end{array}$

Electrical Characteristics (T_J = 25°C, Unless Otherwise Specified)

Inverter Part

Item	Symbol	Conditi	on	Min.	Тур.	Max.	Unit
Collector - Emitter Saturation Voltage	V _{CE(SAT)}	$V_{CC} = V_{BS} = 15V$ $V_{IN} = 0V$	I _C = 15A, T _J = 25°C	-	-	2.3	V
FWDi Forward Voltage	V _{FM}	V _{IN} = 5V	I _C = 15A, T _J = 25°C	-	-	2.5	V
Switching Times	t _{ON}	$V_{PN} = 300V, V_{CC} = V_{BS} = 15V$ $I_{C} = 15A, T_{J} = 25^{\circ}C$		-	0.39	-	us
	t _{C(ON)}			-	0.12	-	us
	t _{OFF}		$V_{IN} = 5V \leftrightarrow 0V$, Inductive Load (High, Low-side)		1.0	-	us
	t _{C(OFF)}	(High, Low-side)			0.6	-	us
	t _{rr}	(Note 4)		-	0.1	-	us
Collector - Emitter Leakage Current	I _{CES}	$V_{CE} = V_{CES}, T_J = 25^{\circ}C$			-	250	uA

Note:

t_{ON} and t_{OFF} include the propagation delay time of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 4.

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Electrical Characteristics

Control Part (T_{.1} = 25°C, Unless Otherwise Specified)

Item	Symbol		Condition	Min.	Тур.	Max.	Unit
Quiescent V _{CC} Supply Cur- rent	IQCCL	$V_{CC} = 15V \qquad V_{CC(L)} - COM_{(L)}$ IN _(UL, VL, WL) = 5V		-	-	26	mA
	I _{QCCH}	V _{CC} = 15V IN _(UH, VH, WH) = 5V	$V_{CC(UH)}, V_{CC(VH)}, V_{CC(WH)} - COM_{(H)}$	-	-	130	uA
Quiescent V _{BS} Supply Cur- rent	I _{QBS}	V _{BS} = 15V IN _(UH, VH, WH) = 5V	$V_{B(U)} - V_{S(U)}, V_{B(V)} - V_{S(V)}, V_{B(W)} - V_{S(W)}$	-	-	420	uA
Fault Output Voltage	V _{FOH}	V_{SC} = 0V, V_{FO} Circuit: 4.7k Ω to 5V Pull-up		4.5	-	-	V
	V _{FOL}	V _{SC} = 1V, V _{FO} Circuit	: 4.7k Ω to 5V Pull-up	-	-	1.1	V
Short-Circuit Trip Level	V _{SC(ref)}	V _{CC} = 15V (Note 5)		0.45	0.51	0.56	V
Sensing Voltage of IGBT Current	V_{SEN}	R_{SC} = 60 Ω , R_{SU} = R_{SV} = R_{SW} = 0 Ω and I_C = 22.5A (Note Fig. 6)		0.45	0.51	0.56	V
Supply Circuit Under-	UV _{CCD}	Detection Level		11.5	12	12.5	V
Voltage Protection	UV _{CCR}	Reset Level		12	12.5	13	V
	UV _{BSD}	Detection Level		7.3	9.0	10.8	V
	UV _{BSR}	Reset Level		8.6	10.3	12	V
Fault Output Pulse Width	t _{FOD}	C _{FOD} = 33nF (Note 6)		1.4	1.8	2.0	ms
ON Threshold Voltage	V _{IN(ON)}	High-Side	Applied between IN _(UH) , IN _(VH) ,	-	-	0.8	V
OFF Threshold Voltage	V _{IN(OFF)}	1	IN _(WH) - COM _(H)	3.0	-	-	V
ON Threshold Voltage	V _{IN(ON)}	Low-Side	Applied between IN _(UL) , IN _(VL) ,	-	-	0.8	V
OFF Threshold Voltage	V _{IN(OFF)}	1	IN _(WL) - COM _(L)	3.0	-	-	V

Note: 5. Short-circuit current protection is functioning only at the low-sides. It would be recommended that the value of the external sensing resistor (R_{SC}) should be selected around 60 Ω in order to make the SC trip-level of about 22.5A at the shunt resistors (R_{SU} , R_{SV} , R_{SW}) of Ω_{Ω} . For the detailed information about the relationship between the external sensing resistor (R_{SC}) and the shunt resistors (R_{SU} , R_{SV} , R_{SW}), please see Fig. 6. 6. The fault-out pulse width t_{FOD} depends on the capacitance value of C_{FOD} according to the following approximate equation : C_{FOD} = 18.3 x 10⁻⁶ x t_{FOD} [F]

Recommended Operating Conditions

ltem	Sumbol	Symbol Condition		Values			
ltem	Symbol Condition		Min.	Тур.	Max.	Unit	
Supply Voltage	V _{PN}	Applied between P - N _U , N _V , N _W		300	400	V	
Control Supply Voltage	V _{CC}	$\begin{array}{l} \mbox{Applied between } V_{CC(UH)}, V_{CC(VH)}, V_{CC(WH)}, \\ \mbox{COM}_{(H)}, V_{CC(L)} - COM_{(L)} \end{array} \begin{array}{l} 1 \end{array}$		15	16.5	V	
High-side Bias Voltage	V_{BS}	Applied between $V_{B(U)}$ - $V_{S(U)}$, $V_{B(V)}$ - $V_{S(V)}$, $V_{B(W)}$ - $V_{S(W)}$		15	16.5	V	
Blanking Time for Preventing Arm-short	t _{dead}	For Each Input Signal		-	-	us	
PWM Input Signal	f _{PWM}	$T_C \le 100^{\circ}C, T_J \le 125^{\circ}C$	-	3	-	kHz	
Input ON Threshold Voltage	V _{IN(ON)}	$\begin{array}{l} \mbox{Applied between IN}_{(UH)}, \mbox{IN}_{(VH)}, \mbox{IN}_{(WH)} - \\ \mbox{COM}_{(H)}, \mbox{IN}_{(UL)}, \mbox{IN}_{(VL)}, \mbox{IN}_{(WL)} - \mbox{COM}_{(L)} \end{array}$		0~0.65	5	V	
Input OFF Threshold Voltage	V _{IN(OFF)}	Applied between IN _(UH) , IN _(VH) , IN _(WH) - 4 ~ 5.5 $COM_{(H)}$, IN _(UL) , IN _(VL) , IN _(WL) - $COM_{(L)}$ 4 ~ 5.5			V		













Note:

- R_{PL}C_{PL}/R_{PH}C_{PH}/R_{PF}C_{PF} coupling at each SPM input is recommended in order to prevent input signals' oscillation and it should be as close as possible to each SPM input bin.
- 2) By virtue of integrating an application specific type HVIC inside the SPM, direct coupling to CPU terminals without any opto-coupler or transformer isolation is possible.
- V_{FO} output is open collector type. This signal line should be pulled up to the positive side of the 5V power supply with approximately 4.7k Ω resistance. Please refer to Fig. 14. 3)
- C_{SP15} of around 7 times larger than bootstrap capacitor C_{BS} is recommended.
- 5) V_{FO} output pulse width should be determined by connecting an external capacitor(C_{FOD}) between C_{FOD}(pin8) and COM_(L)(pin2). (Example : if C_{FOD} = 33 nF, then t_{FO} = 1.8 ms (typ.)) Please refer to the note 6 for calculation method.
- 6) Each input signal line should be pulled up to the 5V power supply with approximately 4.7kΩ resistance (other RC coupling circuits at each input may be needed depending on the PWM control scheme used and on the wiring impedance of the system's printed circuit board). Approximately a 0.22-2nF by-pass capacitor should be used across each power supply connection terminals
- 7) To prevent errors of the protection function, the wiring around R_{SC}, R_F and C_{SC} should be as short as possible.
 8) In the short-circuit protection circuit, please select the R_FC_{SC} time constant in the range 3~4 μs.
 9) To enhance the noise immunity, C_{SC} pin should be connected to the external circuit through a series resistor, R_{CSC}, which is approximately 390Ω. R_{CSC} should be connected to C_{SC} pin as close as possible.
- 10)Each capacitor should be mounted as close to the pins of the SPM as possible. 11)To prevent surge destruction, the wiring between the smoothing capacitor and the P&N pins should be as short as possible. The use of a high frequency non-inductive capacitor of around 0.1~0.22 uF between the P&N pins is recommended.
- 12)Relays are used at almost every systems of electrical equipments of home appliances. In these cases, there should be sufficient distance between the CPU and the relays. It is recommended that the distance be 5cm at least.

Fig. 14. Typical Application Circuit



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